

C0402C102JMGEC7411

ESD SMD Comm COG, Ceramic, 1000 pF, 5%, 63 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0402



Click here for the 3D model.

0402
1mm +/-0.05mm
0.5mm +/-0.05mm
0.5mm +/-0.05mm
0.3mm MIN
0.3mm +/-0.1mm

## **Packaging Specifications**

Packaging Packaging Quantity

T&R, 330mm, Paper Tape 50000

General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	1000 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	63 VDC
ESD Level per AEC-Q200	4,000 V ESD Level
Dielectric Withstanding Voltage	157.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms
Insulation Resistance	100 GOnms

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